

# FMC20N50E

FUJI POWER MOSFET

## Super FAP-E<sup>3</sup> series

## N-CHANNEL SILICON POWER MOSFET

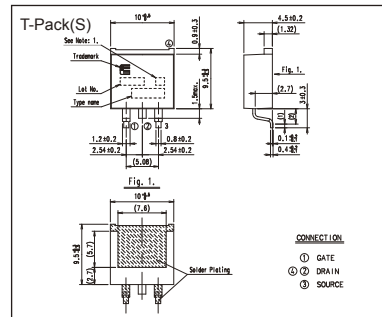
### Features

- Maintains both low power loss and low noise
- Lower  $R_{DS(on)}$  characteristic
- More controllable switching  $dv/dt$  by gate resistance
- Smaller  $V_{GS}$  ringing waveform during switching
- Narrow band of the gate threshold voltage ( $3.0 \pm 0.5V$ )
- High avalanche durability

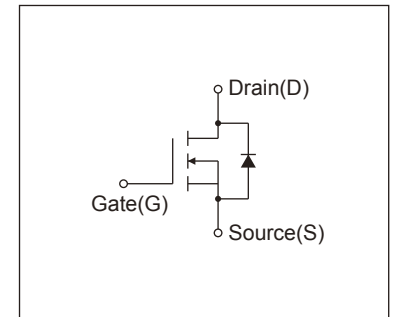
### Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

### Outline Drawings [mm]



### Equivalent circuit schematic



### Maximum Ratings and Characteristics

#### Absolute Maximum Ratings at $T_c=25^\circ C$ (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-Source Voltage	$V_{DS}$	500	V	
	$V_{DSX}$	500	V	$V_{GS} = -30V$
Continuous Drain Current	$I_D$	$\pm 20$	A	
Pulsed Drain Current	$I_{DP}$	$\pm 80$	A	
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	$I_{AR}$	20	A	Note*1
Non-Repetitive Maximum Avalanche Energy	$E_{AS}$	582.5	mJ	Note*2
Repetitive Maximum Avalanche Energy	$E_{AR}$	27	mJ	Note*3
Peak Diode Recovery $dV/dt$	$dV/dt$	7.4	kV/ $\mu s$	Note*4
Peak Diode Recovery $-di/dt$	$-di/dt$	100	A/ $\mu s$	Note*5
Maximum Power Dissipation	$P_D$	2.16	W	$T_a=25^\circ C$
		270		$T_c=25^\circ C$
Operating and Storage Temperature range	$T_{ch}$	150	$^\circ C$	
	$T_{stg}$	-55 to +150	$^\circ C$	

#### Electrical Characteristics at $T_c=25^\circ C$ (unless otherwise specified)

Description	Symbol	Conditions	min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	500	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$I_D=250\mu A, V_{DS}=V_{GS}$	2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=500V, V_{GS}=0V$	-	-	25	$\mu A$
		$V_{DS}=400V, V_{GS}=0V$	-	-	250	
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V, V_{DS}=0V$	-	10	100	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$I_D=10A, V_{GS}=10V$	-	0.27	0.31	$\Omega$
Forward Transconductance	$g_{fs}$	$I_D=10A, V_{DS}=25V$	11	22	-	S
Input Capacitance	$C_{iss}$	$V_{DS}=25V$	-	2650	3980	pF
Output Capacitance	$C_{oss}$	$V_{GS}=0V$	-	250	375	
Reverse Transfer Capacitance	$C_{rss}$	$f=1MHz$	-	19	28.5	
Turn-On Time	$t_{d(on)}$	$V_{cc}=300V$	-	22	33	ns
	$t_r$	$V_{GS}=10V$	-	11	16.5	
Turn-Off Time	$t_{d(off)}$	$I_D=10A$	-	120	180	
	$t_f$	$R_{GS}=10\Omega$	-	21	31.5	
Total Gate Charge	$Q_G$	$V_{cc}=250V$	-	77	115.5	nC
Gate-Source Charge	$Q_{GS}$	$I_D=20A$	-	17	25.5	
Gate-Drain Charge	$Q_{GD}$	$V_{GS}=10V$	-	22	33	
Avalanche Capability	$I_{AV}$	$L=1.07mH, T_{ch}=25^\circ C$	20	-	-	A
Diode Forward On-Voltage	$V_{SD}$	$I_F=20A, V_{GS}=0V, T_{ch}=25^\circ C$	-	0.90	1.35	V
Reverse Recovery Time	$t_{rr}$	$I_F=20A, V_{GS}=0V$	-	0.5	-	$\mu s$
Reverse Recovery Charge	$Q_{rr}$	$-di/dt=100A/\mu s, T_{ch}=25^\circ C$	-	7	-	$\mu C$

#### Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	$R_{th(ch-c)}$	Channel to Case			0.460	$^\circ C/W$
	$R_{th(ch-a)}$	Channel to Ambient			62.0	$^\circ C/W$

Note \*1 :  $T_{ch} \leq 150^\circ C$

Note \*2 : Stating  $T_{ch}=25^\circ C, I_{AS}=8A, L=16.7mH, V_{cc}=50V, R_G=50\Omega$

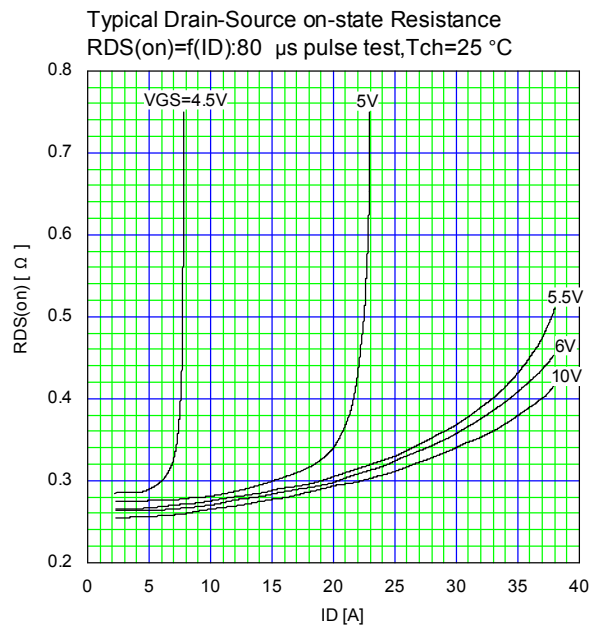
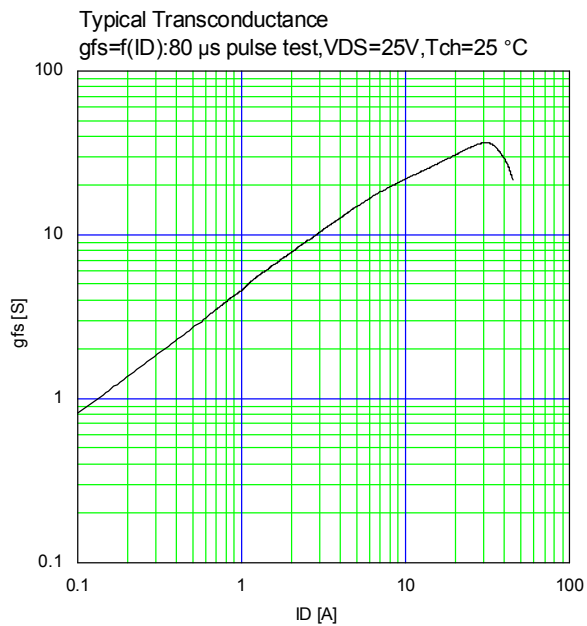
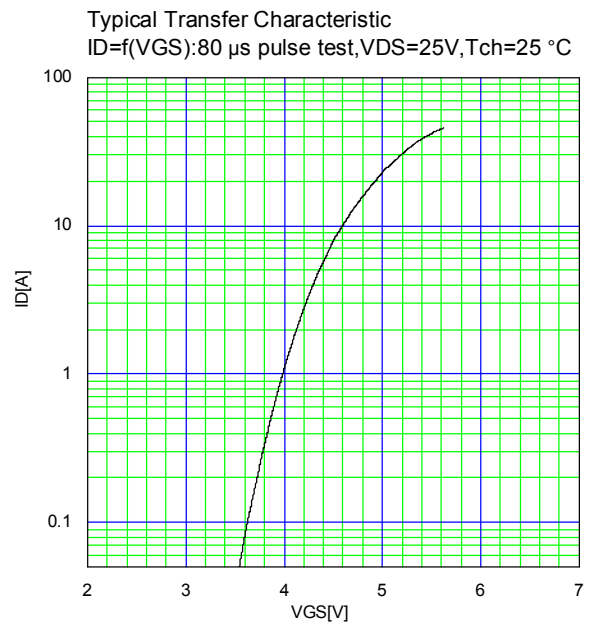
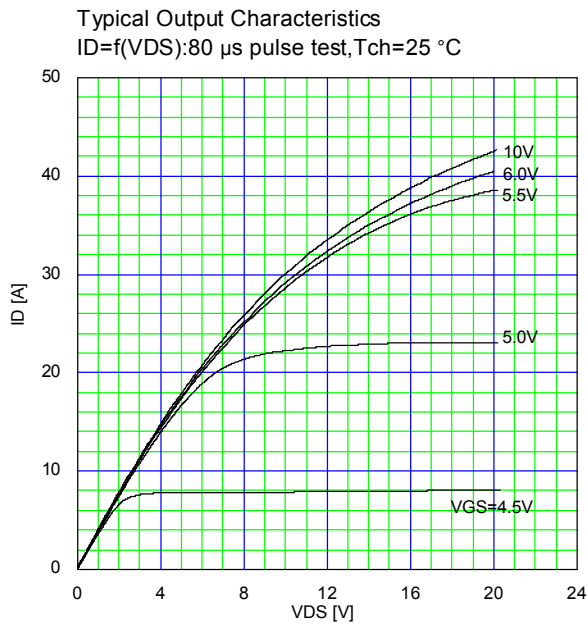
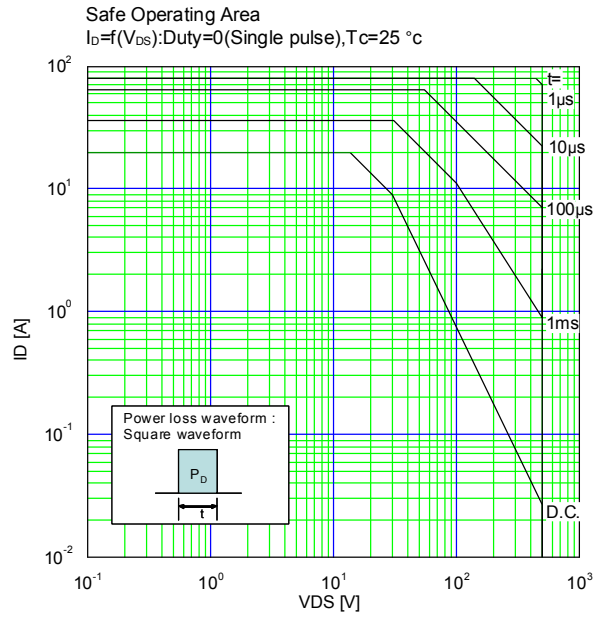
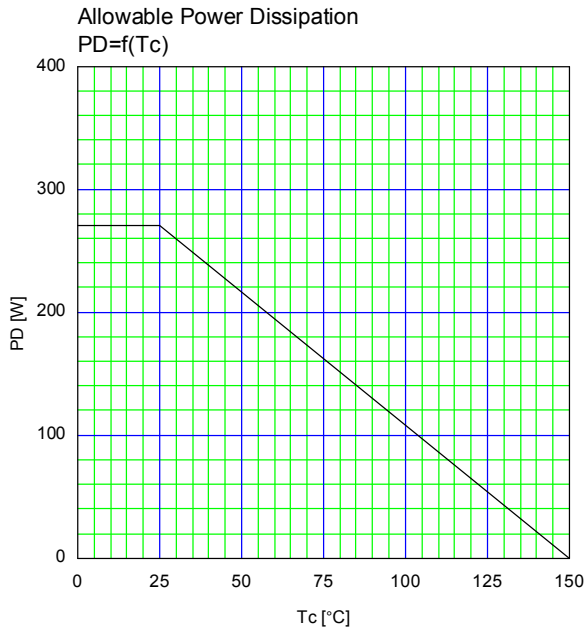
$E_{AS}$  limited by maximum channel temperature and avalanche current.  
See to 'Avalanche Energy' graph.

Note \*3 : Repetitive rating : Pulse width limited by maximum channel temperature.

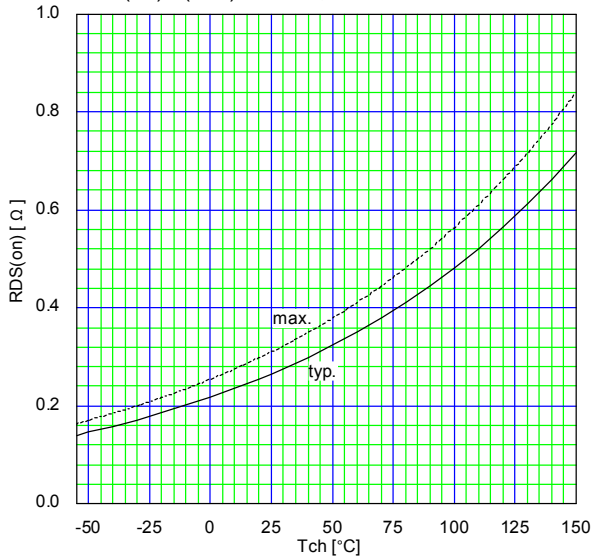
See to the 'Transient Thermal Impedance' graph.

Note \*4 :  $I_F \leq I_D, -di/dt=100A/\mu s, V_{cc} \leq BV_{DSS}, T_{ch} \leq 150^\circ C$ .

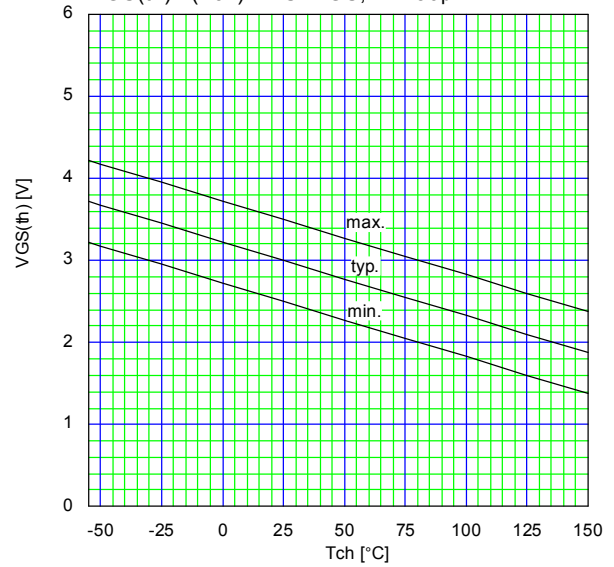
Note \*5 :  $I_F \leq I_D, dv/dt=7.4kV/\mu s, V_{cc} \leq BV_{DSS}, T_{ch} \leq 150^\circ C$ .



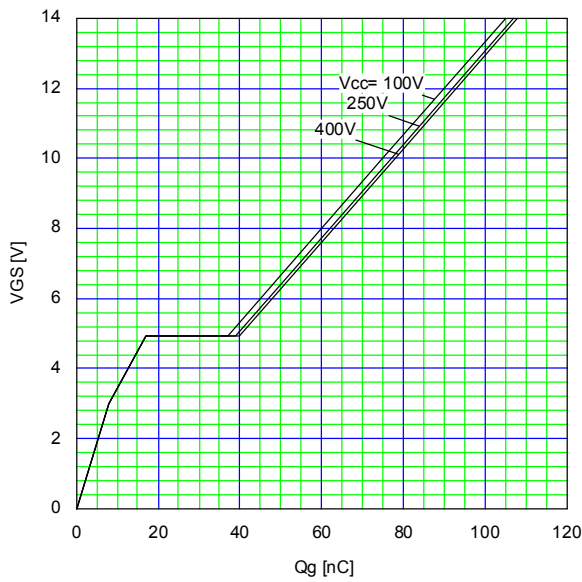
Drain-Source On-state Resistance  
 $R_{DS(on)} = f(T_{ch}): I_D = 10A, V_{GS} = 10V$



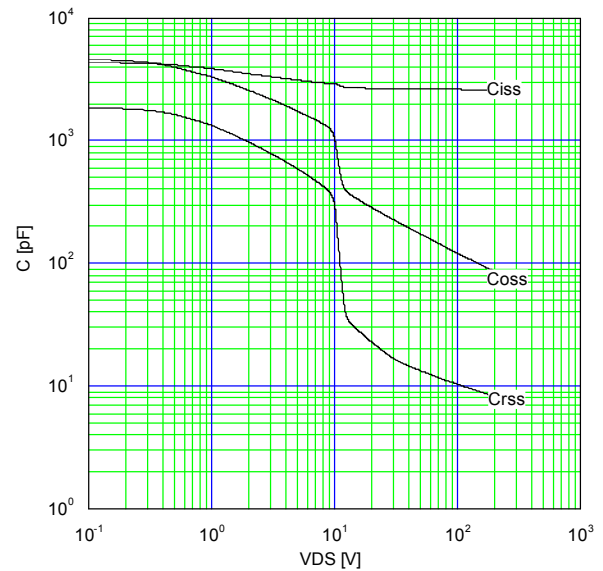
Gate Threshold Voltage vs. T<sub>ch</sub>  
 $V_{GS(th)} = f(T_{ch}): V_{DS} = V_{GS}, I_D = 250\mu A$



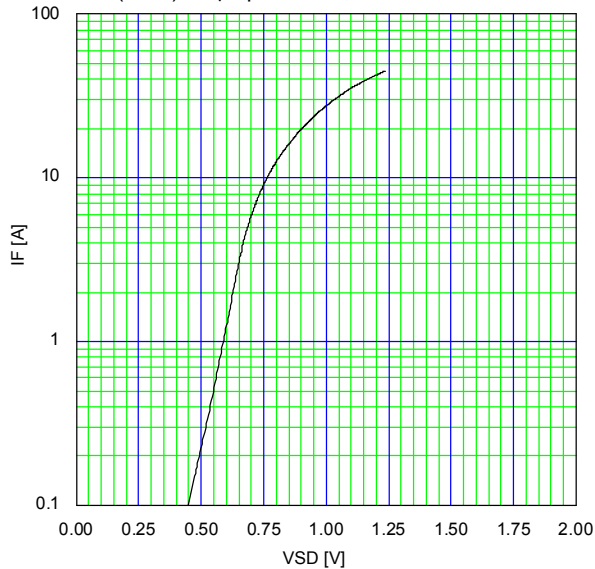
Typical Gate Charge Characteristics  
 $V_{GS} = f(Q_g): I_D = 20A, T_{ch} = 25\text{ °C}$



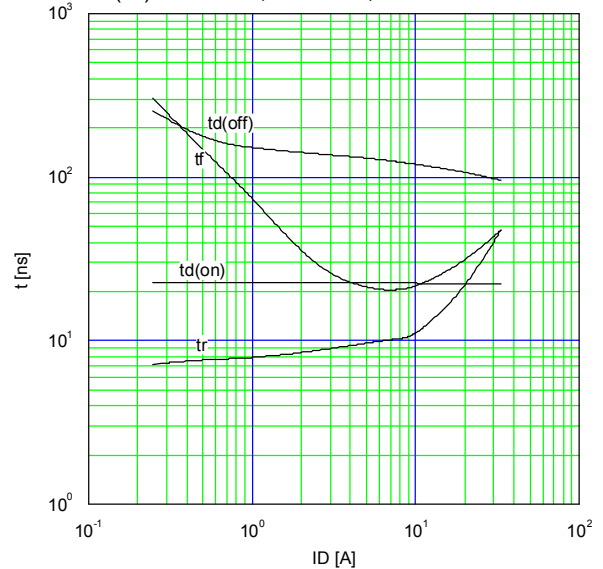
Typical Capacitance  
 $C = f(V_{DS}): V_{GS} = 0V, f = 1MHz$

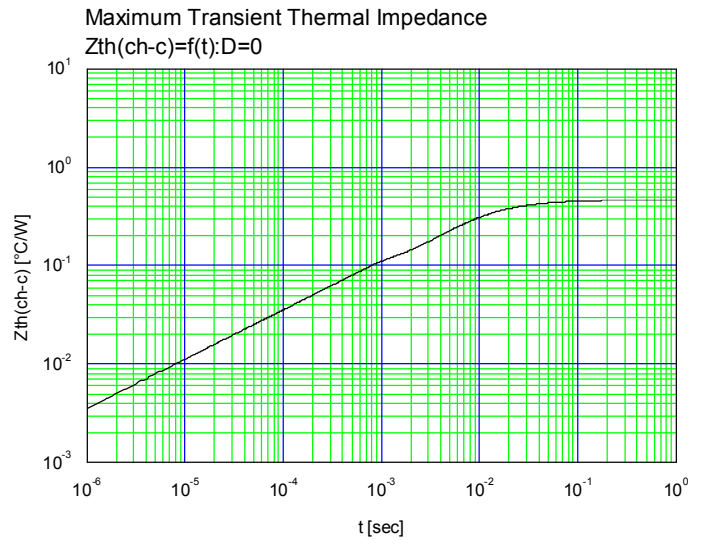
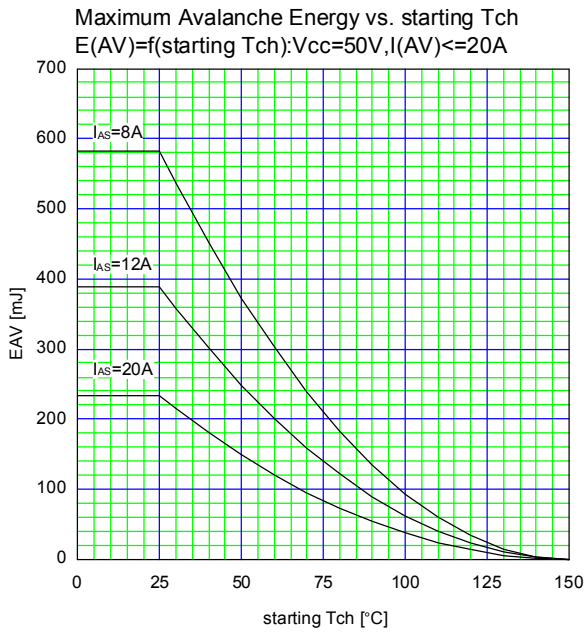


Typical Forward Characteristics of Reverse Diode  
 $I_F = f(V_{SD}): 80\ \mu s\ pulse\ test, T_{ch} = 25\text{ °C}$



Typical Switching Characteristics vs. I<sub>D</sub>  
 $t = f(I_D): V_{cc} = 300V, V_{GS} = 10V, R_G = 10\ \Omega$





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